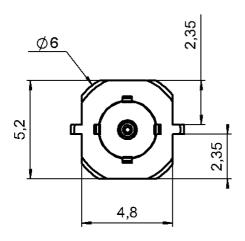
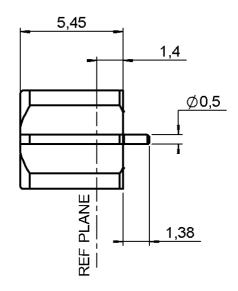
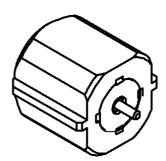
SMT TYPE - EDGE CARD - REEL OF 100

R113.423.820

Series: MCX









Scale : 1/1

All dimensions are in mm.



COMPONENTS	MATERIALS	PLATINGS (µm)
_	ASS RYLLIUM COPPER FE	GOLD 0.2 OVER NICKEL 2 GOLD 0.5 OVER NICKEL 2

Issue: 0419 A

In the effort to improve our products, we reserve the right to make changes judged to be necessary.



SMT TYPE - EDGE CARD - REEL OF 100

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PACKAGING

Standard	Unit	Other	
100	'W' option	Contact us	

SPECIFICATION

ELECTRICAL CHARACTERISTICS

Impedance **50** Ω Frequency **0-6** GHz

VSWR 1.05 +

0.015 x F(GHz) Maxi Insertion loss **0.03** $\sqrt{F(GHz)}$ dB Maxi

RF leakage **NA** - F(GHz)) dB Maxi - (

Voltage rating 335 Veff Maxi Dielectric withstanding voltage 1000 Veff mini Insulation resistance 1000 M Ω mini

ENVIRONMENTAL

-55/+155 ° C Operating temperature

Hermetic seal NA Atm.cm3/s

Panel leakage NA

OTHERS CHARACTERISTICS

Assembly instruction

Others:

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating end 10 N mini Axial force – Opposite end 10 N mini Torque NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 500 Cycles mini

Weight **0.754** g

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R113.423.820

SMT TYPE - EDGE CARD - REEL OF 100

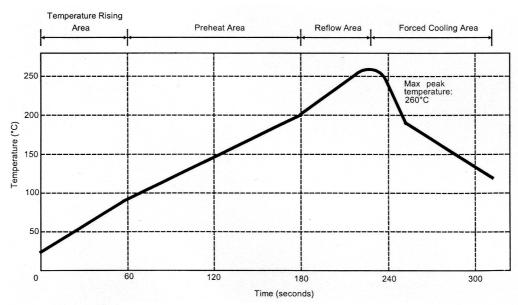
Series: MCX

SOLDER PROCEDURE

- 1. Deposit solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
 - We advise a thickness of 150 micromm (5.850 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. A video camera is recommended for positioning of the component. Adhesive agents must not be used on the receptacle.
- 3. This process of soldering has been tested with convection oven .Below please find ,the typical profile to use.
- 4. The cleaning of printed circuit boards is not obliged .
- 5. Verification of solder joints and position of the component by visual inspection.

NOTE: The receptacle and the plug must not be mated before completion of this procedure

TEMPERATURE PROFILE



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

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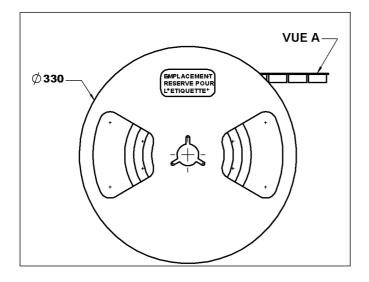
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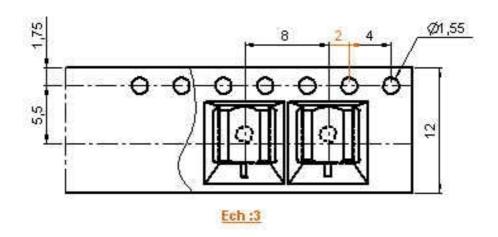
SMT TYPE - EDGE CARD - REEL OF 100

R113.423.820

Series: MCX



bobine Ech: 0.7



Issue: 0419 A

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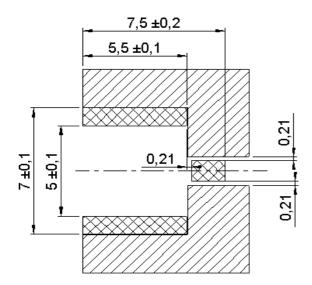


SMT TYPE - EDGE CARD - REEL OF 100

R113.423.820

Series: MCX

MCX SERIES - INFORMATIONS



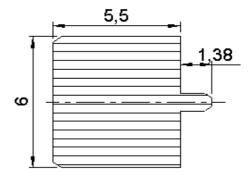




COPLANAR LINE

Pattern and signal are on the same side Thickness of PCB: 1.6mm
The material of PCB is the epoxy resin of glass fabrics bacs.(En –4.8)
The solder resist should be printed exept for the land pattern on the PCB.

SHADOW OF MCX RECEPTACLE FOR VIDEO CAMERA



Issue: 0419 A

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